

High Power Density Integrated Traction Machine Drive

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Project ID: APE024

Overview

Timeline

- Start Date: Jan. 2010
- End Date: Sept. 2012
- 10% Complete

Budget

- DOE Share – 100%
- FY10 received: \$389K
- FY11 requested: \$500K

Barriers

- Barriers:
 - Simultaneously achieve high performance and fault tolerance while meeting high power density targets.
 - Ability to use low cost devices (Si) with acceptable high-temperature performance and reliability.
- Target: Power density >4 kW/L, and efficiency > 94%, 150 °C ambient and 200 °C junction temperatures

Partners

- University of Wisconsin
- University of Tennessee

Objective

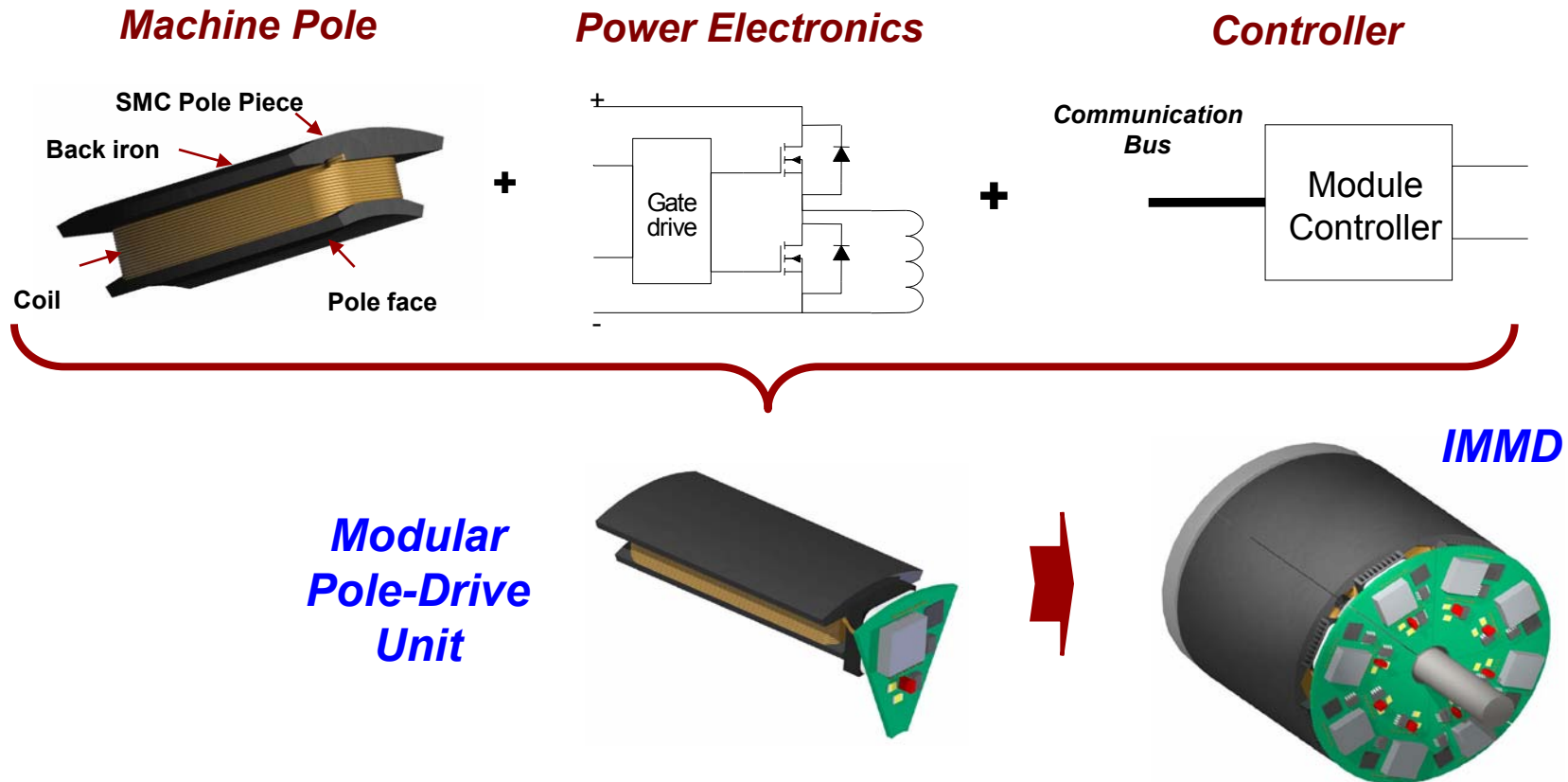
- Develop a reliable, fault-tolerant, integrated modular motor drive (IMMD) that is capable of operating at 200°C junction and 150°C ambient temperatures.
- FY10
 - Design a demonstrator version of the integrated modular motor drive (IMMD) with fault-tolerant controller using the most promising configuration to verify performance characteristics including power density and fault tolerance
 - Evaluate Si IGBT and suitable packaging at 200°C considering device characteristics, loss and cooling, as well as reliability

Milestone

- **August 2010:** Complete the design of next-generation low-power (10 kW) demonstrator IMMD motor; Characterize the Si IGBT operation at 200°C junction temperature, and finish the layout and cooling design.
- *Go/No Go* – Design reviews to evaluate performance and fault tolerance capability, and to determine if prototype machine are ready for construction.

Approach/Strategy

Integrated Modular Motor Drive (IMMD) Concept



Each modular pole-drive unit performs as an independent building block in the motor drive stator configuration

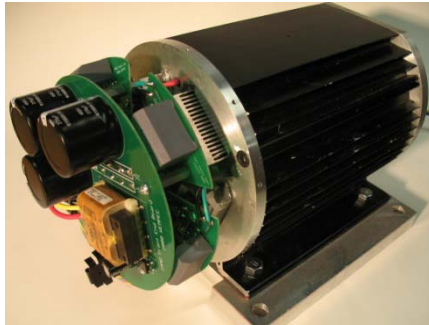
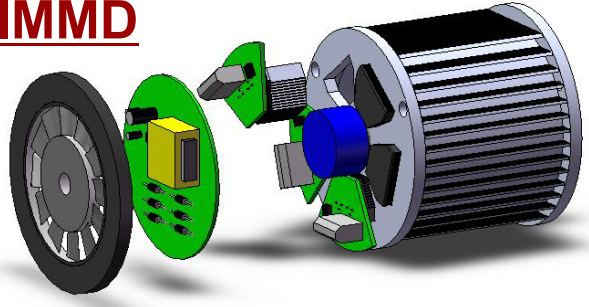
Approach/Strategy (cont'd)

Meet the cost and power density target by

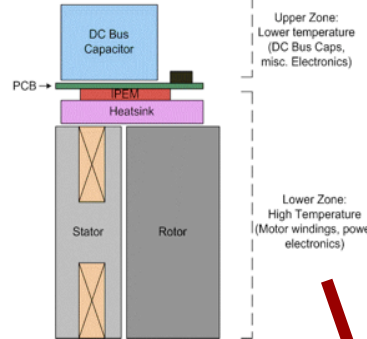
- modularizing both the machine and power electronics and then integrating them together into a single combined machine-plus-drive structure
- extending Si device operation to higher temperatures and utilizing the advanced packaging approaches

Previous Accomplishments

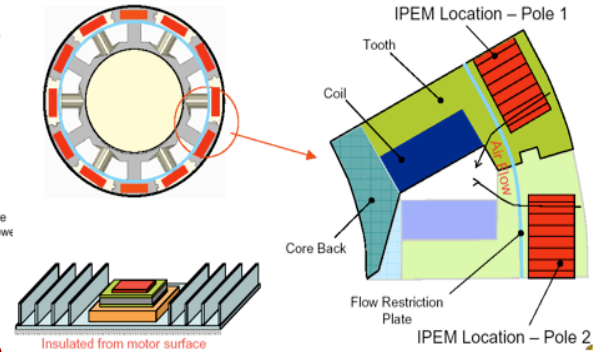
Demonstrator 5-Phase low power IMM



Proposed Zonal Thermal Design

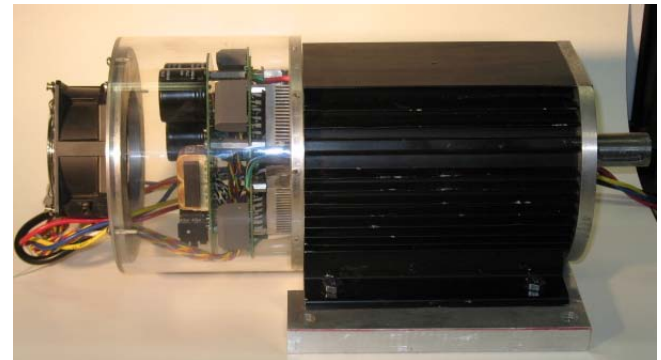
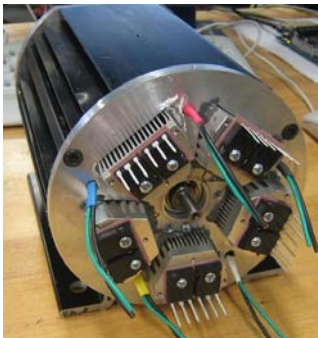


IMMD Thermal Analysis Model



To

*Integrated modular
5-phase motor
drive*



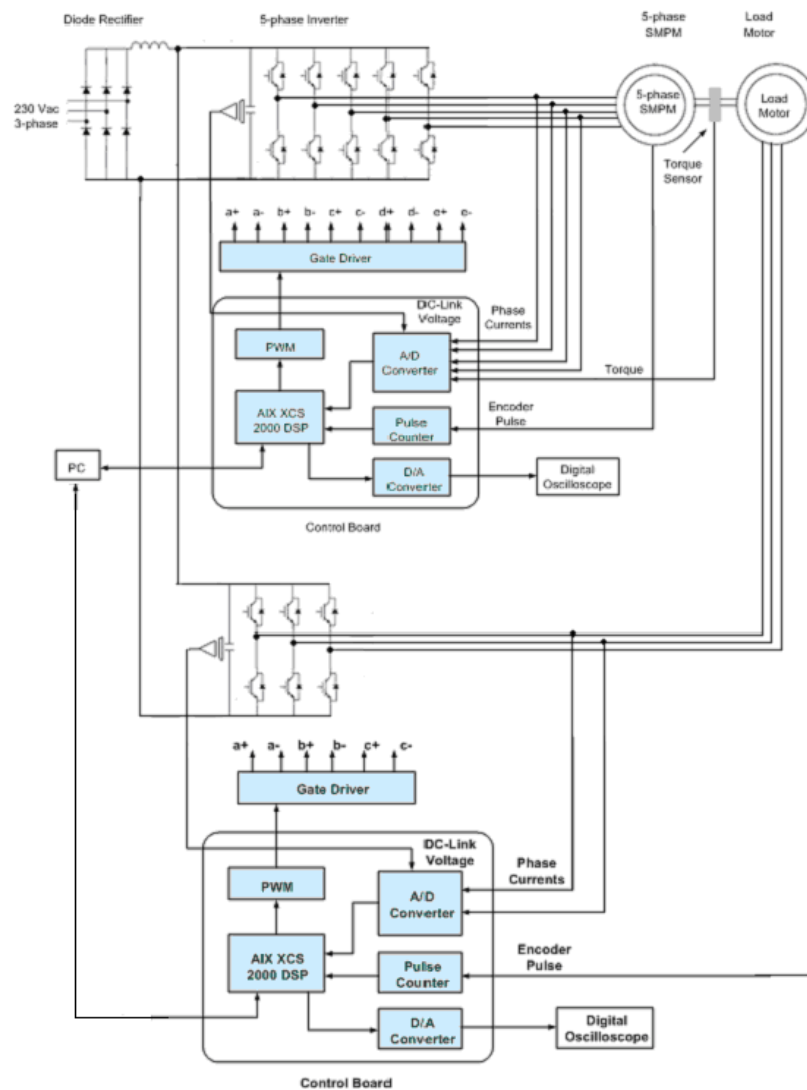
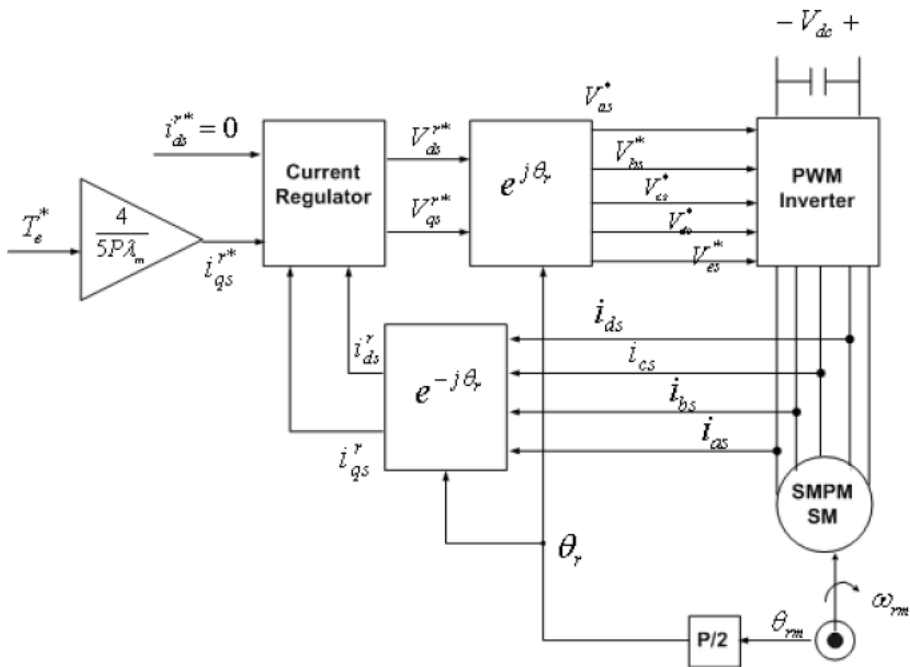
FY10 Technical Accomplishments

IMMD System:

- **5-phase demonstrator IMMD used as starting point for new investigation**
- **Vector control algorithm adopted for torque controller**
 - Synchronous frame current regulator
 - Encoder provides rotor position feedback
 - Decoupling techniques introduced for improved dynamic performance
- **Simulation used to explore predicted IMMD drive performance with vector controller**
- **Controller hardware configuration defined using AIX DSP-based controller**

FY10 Technical Accomplishments (cont'd)

IMMD Controller



FY10 Technical Accomplishments (cont'd)

Simulation Results

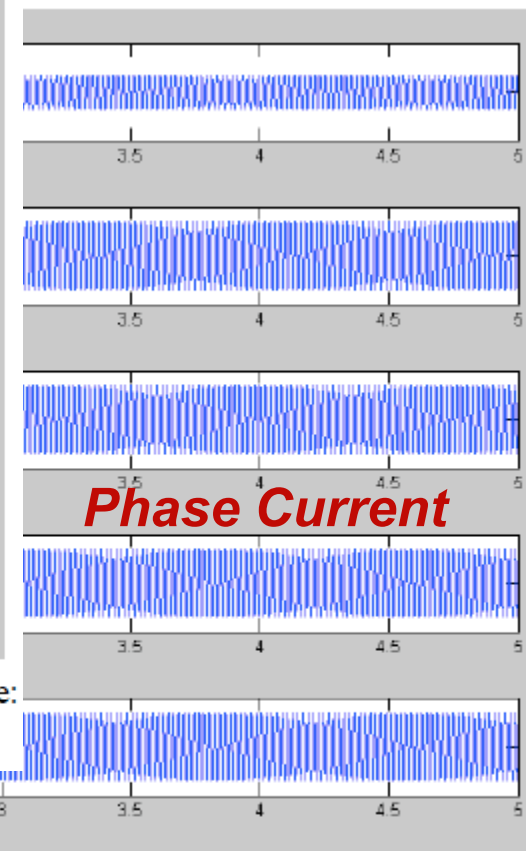
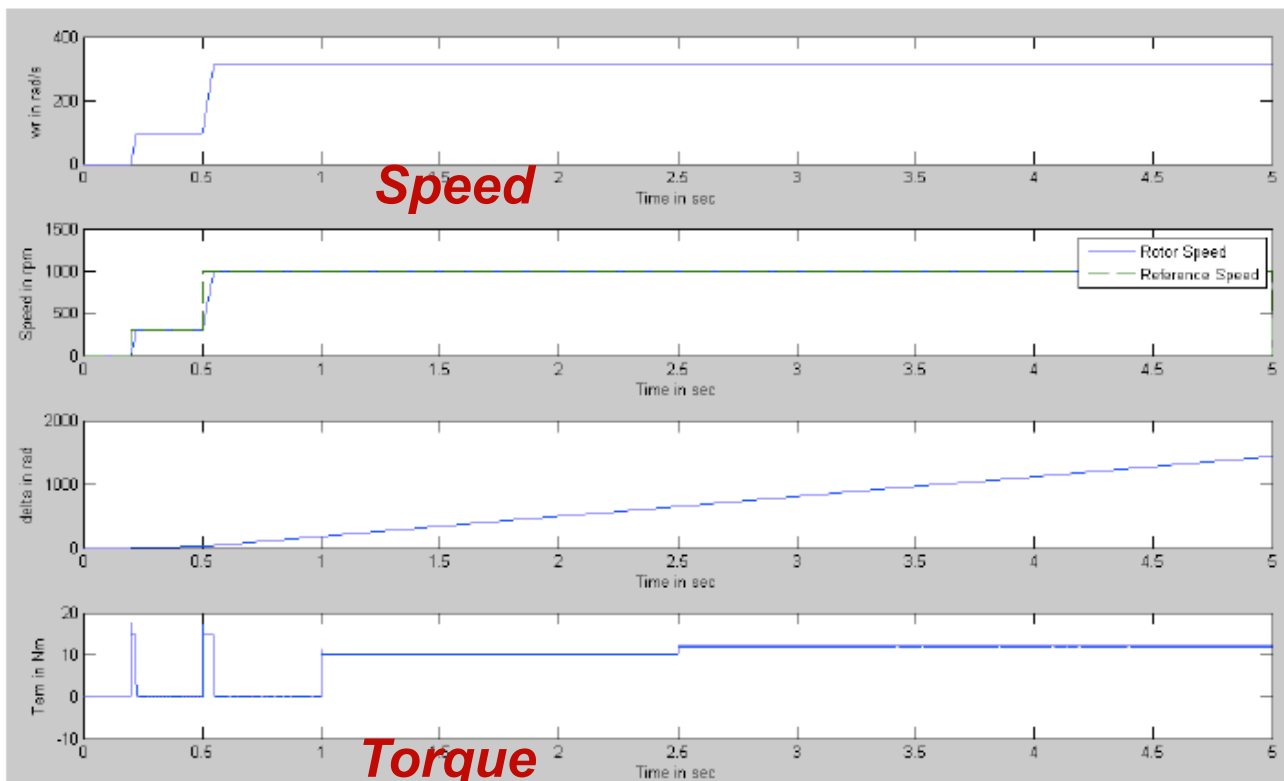


Fig. 14(b) w_r , δ , and T_{em} waveforms under step change in speed reference and load torque:

300 rpm @ 0.2 sec and 1000 rpm @ 0.5 sec. 10 Nm @ 1 sec and 12 Nm @ 2.5 sec.

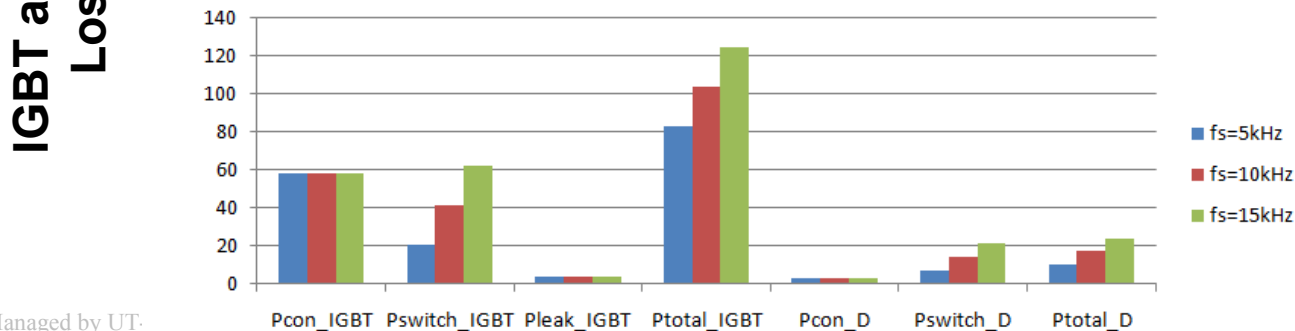
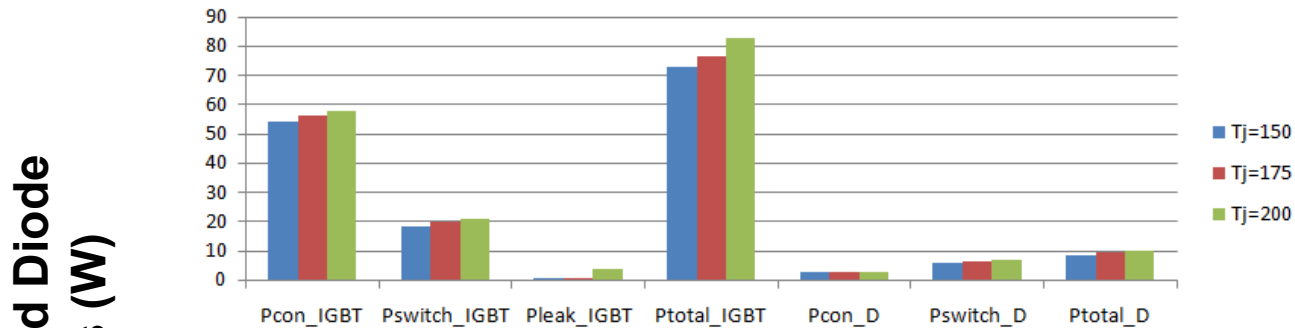
Fig. 14(d) i_a , i_b , i_c , i_d , and i_e under step change in speed reference and load torque:

300 rpm @ 0.2 sec and 1000 rpm @ 0.5 sec. 10 Nm @ 1 sec and 12 Nm @ 2.5 sec.

FY10 Technical Accomplishments (cont'd)

Device Evaluation

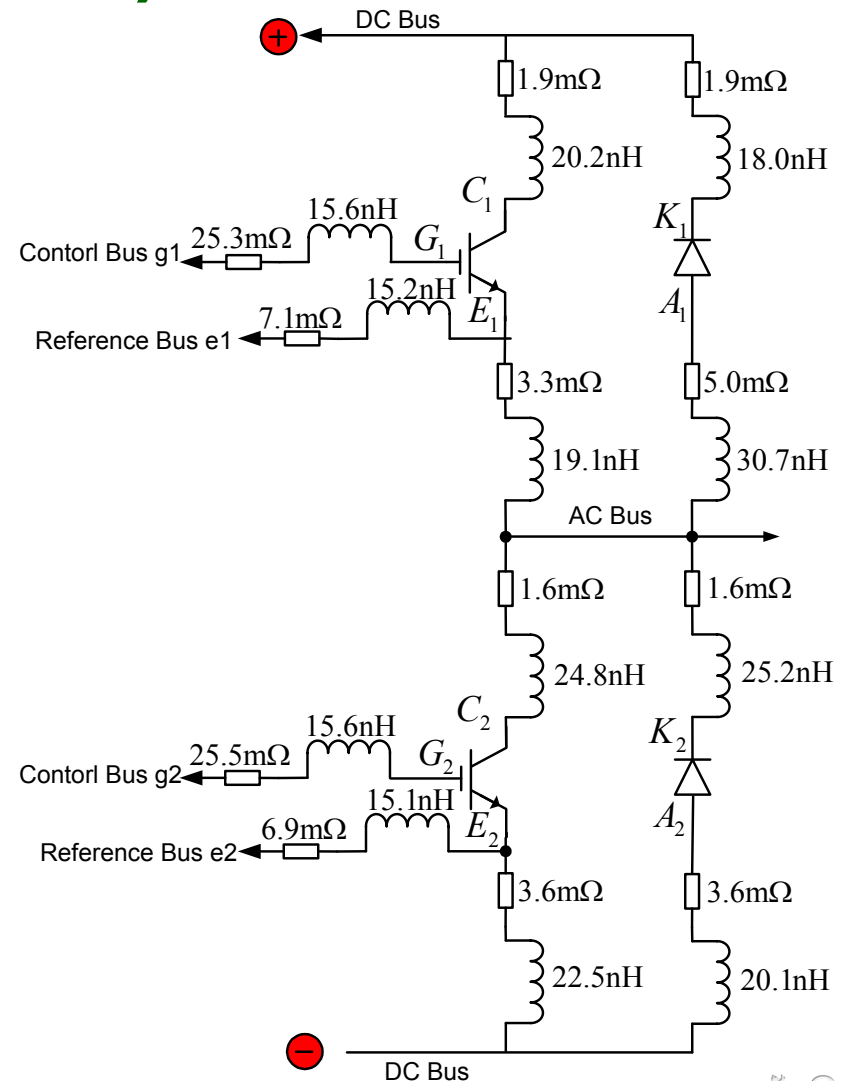
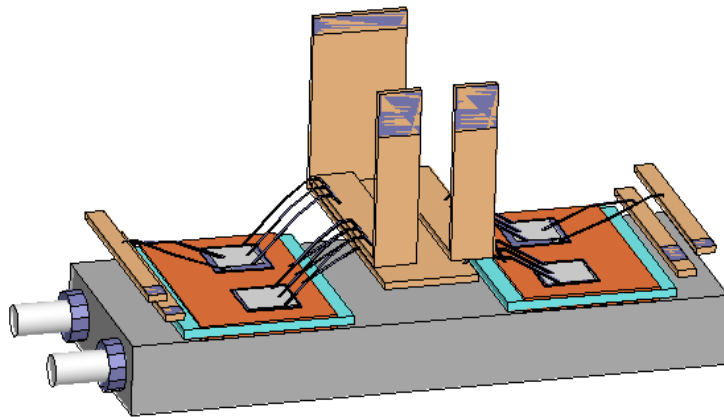
- Baseline devices for evaluations selected (IKW40N120H3 – Trench Fieldstop IGBT)
- Loss calculations show the loss increase due to elevated temperature manageable



FY10 Technical Accomplishments (cont'd)

Device Packaging

- **Baseline packaging structures and materials selected**
- **Phase-leg layout designed**
- **Baseline cooling system designed**



Collaboration

- **Partners**
 - **University of Wisconsin (Academic): Subcontractor, design and develop integrated modular motor drive system**
 - **University of Tennessee (Academic): Subcontractor, design and develop power modules based on Si devices operating at 150° C ambient and 200° C junction temperatures**

Future Work – FY10

- **Design next-generation 10 kW demonstrator IMMD motor**
- **Design hardware and software of the controller for demonstrator IMMD**
- **Characterize and test Si IGBT and diode module at 200°C**
- **Select IGBT/diode dies and design the high temperature packaging for 10 kW phase-leg power module to be used for full power (55 kW peak) IMMD**

Future Work – FY11 and beyond

- **Build and test 10 kW demonstrator IMMD to evaluate drive system performance and fault tolerance**
- **Develop the 10 kW phase-leg power modules needed for implementing the full power IMMD. The modules should be based on low cost Si and can operate in ambient temperatures of 150°C, with junction temperatures up to 200°C.**
- **Scale up the power level of the IMMD technology and combine with the high temperature modules to achieve high-density integrated traction motor drive.**

Summary

A high-density integrated motor drive is being developed that will feature:

- Modular power electronics and motor integrated in a single structure with fault tolerance**
- High temperature capability based on low cost Si devices and novel packaging, capable of operating at 150°C ambient and 200°C junction temperatures with 105°C oil cooling**
- Power density and efficiency meeting DOE 2020 targets**